



# **Product Change Notification**

## **113755 - 00**

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# Product Change Notification

**Change Notification #:** 113755 - 00  
**Change Title:** Intel® Integrated RAID Module  
RMS25PB040, RMS25PB080, RMT3PB080,  
RMS25KB040, and RMS25KB080  
PCN 113755-00, Transport Media, Product  
Marking  
Update the Package  
**Date of Publication:** April 1, 2015

## Key Characteristics of the Change:

Transport Media, Product Marking

## Forecasted Key Milestones:

<b>Date Customer Must be Ready to Receive Post-Conversion Material*:</b>	Apr 20, 2015
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*\* Intel appreciates the customer's desire to receive the latest revision of products. However, Intel manages inventory on a first in first out (FIFO) basis at the MM# level. Subsequently, customer requests for a specific revision of material (below the MM#) will not be supported by Intel.*

## Description of Change to the Customer:

Intel is implementing the following changes on the carton outer box for the Intel® Integrated RAID Module RMS25PB040, RMS25PB080, RMT3PB080, RMS25KB040, and RMS25KB080 to meet the new Intel package standards and procedures:

1. Add the International Standard ISO 780 symbols including No.1 "FRAGILE", No.3 "THIS WAY UP", and No.6 "KEEP AWAY FROM RAIN".



2. Update the required recycling symbols including the Internationally Recognized Recycling symbol for paper and the FIBRE ASSOCIATION (FBA) "Corrugated Recycles" symbol.



3. Remove the UL logo and printed statement of "To save the earth 100% of the package material used is recyclable".

### **Customer Impact of Change and Recommended Action:**

Intel anticipates no impact to customers, but encourages customers to understand the changes and determine the impact on their applications.

### **Products Affected / Intel Ordering Codes:**

<b>Product Code</b>	<b>MM#</b>	<b>Pre Change TA</b>	<b>Pre Change PBA</b>	<b>Post Change TA</b>	<b>Post Change PBA</b>
RMS25KB080	924454	G34902-311	G35828-311	G34902-312	G35828-311
RMS25KB040	924455	G34903-311	G36694-311	G34903-312	G36694-311
RMS25PB080	924868	G34888-612	G27504-612	G34888-613	G27504-612
RMS25PB040	924869	G34892-612	G45802-612	G34892-613	G45802-612
RMT3PB080	924870	G34893-612	G45803-612	G34893-613	G45803-612

### **PCN Revision History:**

**Date of Revision:**

April 1, 2015

**Revision Number:**

00

**Reason:**

Originally Published PCN